

March 2013

FCP13N60N / FCPF13N60NT

N-Channel SupreMOS[®] MOSFET

600 V, 13 A, 258 m Ω

Features

- $R_{DS(on)}$ = 244 $m\Omega$ (Typ.) @ V_{GS} = 10 V, I_D = 6.5 A
- Ultra Low Gate Charge (Typ.Q_g = 30.4 nC)
- Low Effective Output Capacitance (Typ. C_{oss}.eff = 145 pF)
- 100% Avalanche Tested
- · RoHS Compliant

Application

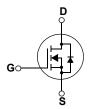
- LCD/LED/PDP TV
- Lighting
- · Solar Inverter
- · AC-DC Power Supply

Description

The SupreMOS® MOSFET is Fairchild Semiconductor® s next generation of high voltage super-junction (SJ) technology employing a deep trench filling process that differentiates it from the conventional SJ MOSFETs. This advanced technology and precise process control provides lowest Rsp on-resistance, superior switching performance and ruggedness. SupreMOS MOSFET is suitable for high frequency switching power converter applications such as PFC, server/telecom power, FPD TV power, ATX power and industrial power applications.







MOSFET Maximum Ratings $T_C = 25^{\circ}C$ unless otherwise noted

Symbol		Parameter		FCP13N60N	FCPF13N60NT	Unit
V _{DSS}	Drain to Source Voltage			(V	
V _{GSS}	Gate to Source Voltage			:	±30	V
	Danie Comment	-Continuous (T _C = 25°C)		13	13*	^
ID	Drain Current	-Continuous (T _C = 100°C)		8.2	8.2*	Α
I_{DM}	Drain Current	- Pulsed	(Note 1)	39	39	Α
E _{AS}	Single Pulsed Avalanche Energ	у	(Note 2)	:	mJ	
I _{AR}	Avalanche Current			4.3		Α
E _{AR}	Repetitive Avalanche Energy 1.16			mJ		
dv/dt	MOSFET dv/dt Ruggedness			100		V/ns
av/al	Peak Diode Recovery dv/dt		(Note 3)		20	V/ns
D	Dower Dissinction	(T _C = 25°C)		116	33.8	W
P_{D}	Power Dissipation	- Derate above 25°C		0.93	0.27	W/°C
T _J , T _{STG}	Operating and Storage Temperature Range -55 to +150			°C		
T _L	Maximum Lead Temperature for Soldering Purpose, 1/8" from Case for 5 Seconds				°C	

*Drain current limited by maximum junction temperature

Thermal Characteristics

Symbol	Parameter F		FCPF13N60NT	Unit
$R_{\theta JC}$	Thermal Resistance, Junction to Case		3.7	
$R_{\theta CS}$	Thermal Resistance, Case to Heak Sink (Typical)	0.5	0.5	°C/W
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient	62.5	62.5	

Package Marking and Ordering Information

Device Marking	Device	Package	Reel Size	Tape Width	Quantity
FCP13N60N	FCP13N60N	TO-220	-	-	50
FCPF13N60NT	FCPF13N60NT	TO-220F	-	-	50

Electrical Characteristics $T_C = 25^{\circ}C$ unless otherwise noted

Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Unit
Off Charac	eteristics					
BV _{DSS}	Drain to Source Breakdown Voltage	$I_D = 1 \text{ mA}, V_{GS} = 0 \text{ V}, T_C = 25^{\circ}\text{C}$	600	-	-	V
$\frac{\Delta BV_{DSS}}{\Delta T_J}$	Breakdown Voltage Temperature Coefficient	I _D = 1 mA, Referenced to 25°C	-	0.73	-	V/°C
1	Zoro Cata Valtaga Prain Current	V _{DS} = 480 V, V _{GS} = 0 V	-	-	10	
IDSS	Zero Gate Voltage Drain Current	$V_{DS} = 480 \text{ V}, V_{GS} = 0 \text{ V}, T_{C} = 125^{\circ}\text{C}$	-	-	100	μΑ
I _{GSS}	Gate to Body Leakage Current	V _{GS} = ±30 V, V _{DS} = 0 V	-	-	±100	nA

On Characteristics

V _{GS(th)}	Gate Threshold Voltage	$V_{GS} = V_{DS}, I_{D} = 250 \mu\text{A}$	2.0	-	4.0	V
R _{DS(on)}	Static Drain to Source On Resistance	$V_{GS} = 10 \text{ V}, I_D = 6.5 \text{ A}$	-	0.220	0.258	Ω
9 _{FS}	Forward Transconductance	V _{DS} = 40 V, I _D = 6.5 A	-	16.3	-	S

Dynamic Characteristics

C _{iss}	Input Capacitance	V 400 V V 0 V		1325	1765	pF
C _{oss}	Output Capacitance	V _{DS} = 100 V, V _{GS} = 0 V f = 1 MHz	-	50	65	pF
C _{rss}	Reverse Transfer Capacitance	1 - 1 1011 12	-	3	5	pF
C _{oss}	Output Capacitance	V _{DS} = 380 V, V _{GS} = 0 V, f = 1 MHz	-	30	-	pF
C _{oss} eff	Effective Output Capacitance	V _{DS} = 0 V to 480 V, V _{GS} = 0 V	-	145	-	pF
Q _{g(tot)}	Total Gate Charge at 10V	$V_{DS} = 380 \text{ V}, I_{D} = 6.5 \text{ A}$	-	30.4	39.5	nC
Q_{gs}	Gate to Source Gate Charge	V _{GS} = 10 V	-	6.0	-	nC
Q_{gd}	Gate to Drain "Miller" Charge	(Note 4)	-	9.5	-	nC
ESR	Equivalent Series Resistance (G-S)	Drain Open	-	2.8	-	Ω

Switching Characteristics

t _{d(on)}	Turn-On Delay Time		-	14.5	39	ns
t _r	Turn-On Rise Time	$V_{DD} = 380 \text{ V}, I_D = 6.5 \text{ A}$	-	10.6	31.2	ns
t _{d(off)}	Turn-Off Delay Time	$R_G = 4.7 \Omega$	-	45	100	ns
t _f	Turn-Off Fall Time	(Note 4)	-	9.8	29.6	ns

Drain-Source Diode Characteristics

I _S	Maximum Continuous Drain to Source Diode Forward Current			-	13	Α
I_{SM}	Maximum Pulsed Drain to Source Diode Forward Current			-	39	Α
V_{SD}	Drain to Source Diode Forward Voltage	V _{GS} = 0 V, I _{SD} = 6.5 A	-	-	1.2	V
t _{rr}	Reverse Recovery Time	V _{GS} = 0 V, I _{SD} = 6.5 A	-	287	-	ns
Q _{rr}	Reverse Recovery Charge	$dI_F/dt = 100 A/\mu s$	-	3.5	-	μС

- **Notes:**1. Repetitive Rating: Pulse width limited by maximum junction temperature
- 2. I_{AS} = 4.3 A, R_{G} = 25 Ω , Starting T_{J} = 25°C
- 3. I $_{SD}$ \leq 13 A, di/dt \leq 200 A/ μ s, V $_{DD}$ \leq BV $_{DSS}$, Starting T $_{J}$ = 25°C
- 4. Essentially Independent of Operating Temperature Typical Characteristics

Typical Performance Characteristics

Figure 1. On-Region Characteristics

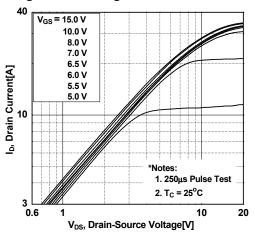


Figure 3. On-Resistance Variation vs.

Drain Current and Gate Voltage

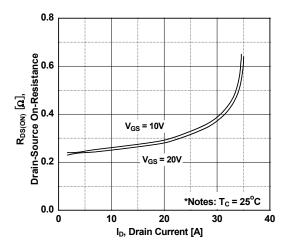


Figure 5. Capacitance Characteristics

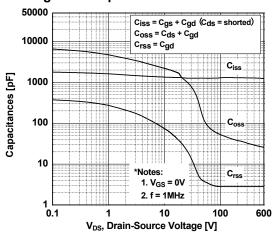


Figure 2. Transfer Characteristics

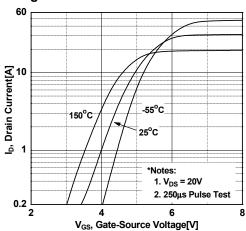


Figure 4. Body Diode Forward Voltage Variation vs. Source Current and Temperature

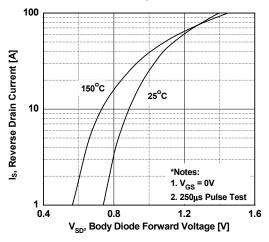
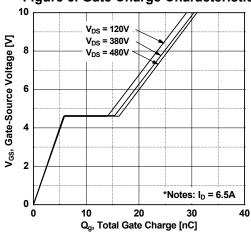


Figure 6. Gate Charge Characteristics



Typical Performance Characteristics (Continued)

Figure 7. Breakdown Voltage Variation vs. Temperature

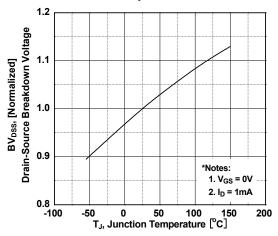


Figure 9. Maximum Safe Operating Area _ FCP13N60N

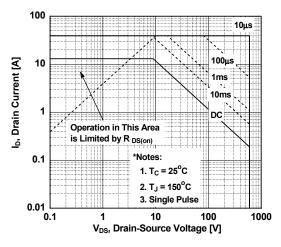


Figure 11. Maximum Drain Current vs. Case Temperature

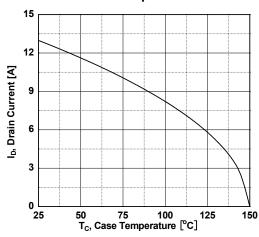


Figure 8. On-Resistance Variation vs. Temperature

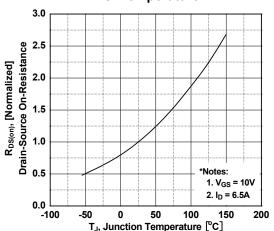
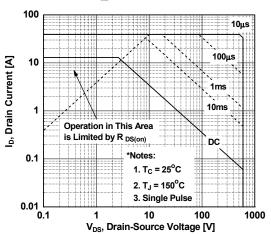


Figure 10. Maximum Safe Operating Area _ FCPF13N60NT



Typical Performance Characteristics (Continued)

Figure 12. Transient Thermal Response Curve _ FCP13N60N

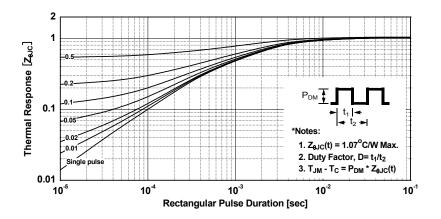
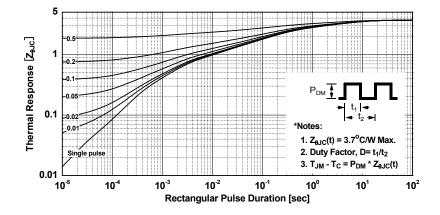
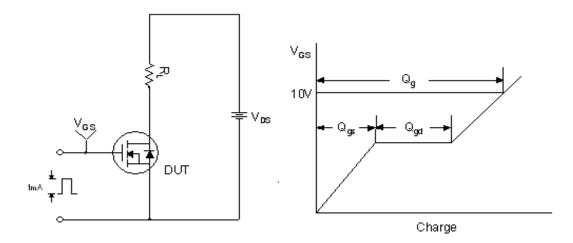


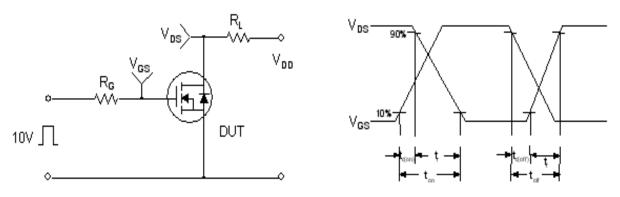
Figure 13. Transient Thermal Response Curve _ FCPF13N60NT



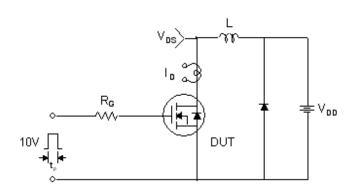
Gate Charge Test Circuit & Waveform

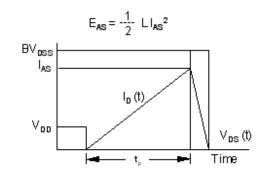


Resistive Switching Test Circuit & Waveforms

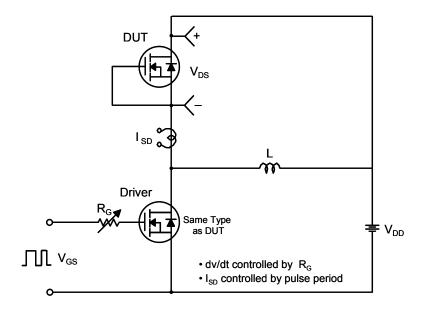


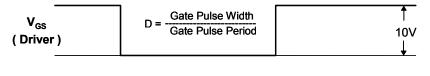
Unclamped Inductive Switching Test Circuit & Waveforms

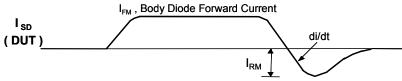




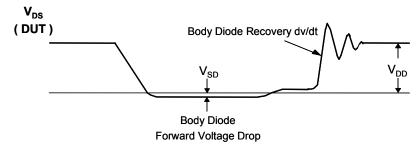
Peak Diode Recovery dv/dt Test Circuit & Waveforms





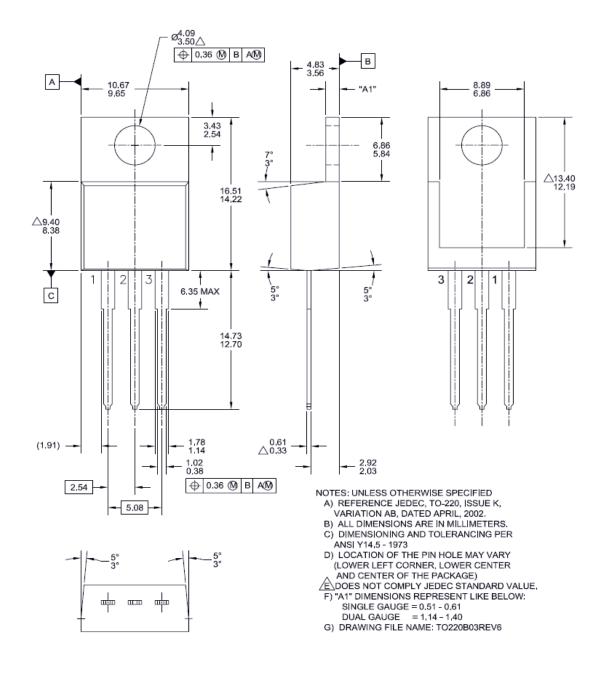


Body Diode Reverse Current



Mechanical Dimensions

TO-220



Mechanical Dimensions TO-220F 2.742.34 10.36 Α 9.96 **Ø**3.28 7.00 3.40 3.08 0.70 3.20 SEE NOTE "F" SEE NOTE "F" 6.88 6.48 (+)1 X 45° 16.07 15.67 16.00 15.60 (3.23) B 3 1.47 2.96 1.24 2.14 2.56 0.90 10.05 0.70 9.45 ⊕ 0.50 M A 30° 0.45 0.60 0.25 0.45 2.54 2.54 NOTES: A. EXCEPT WHERE NOTED CONFORMS TO EIAJ SC91A. DOES NOT COMPLY EIAJ STD. VALUE. C. ALL DIMENSIONS ARE IN MILLIMETERS. D. DIMENSIONS ARE EXCLUSIVE OF BURRS, MOLD FLASH AND TIE BAR PROTRUSIONS. E. DIMENSION AND TOLERANCE AS PER ASME 4.90 <u>/</u>B\ 4.50 Y14.5-1994 F. OPTION 1 - WITH SUPPORT PIN HOLE. OPTION 2 - NO SUPPORT PIN HOLE. G. DRAWING FILE NAME: TO220M03REV3 **Dimensions in Millimeters**





TRADEMARKS

The following includes registered and unregistered trademarks and service marks, owned by Fairchild Semiconductor and/or its global subsidiaries, and is not intended to be an exhaustive list of all such trademarks

(1)_®

2Cool™ FPS™ AccuPower™ F-PFS™ AX-CAP® FRFET®

Global Power ResourceSM BitSiC™ Build it Now™ Green Bridge™ CorePLUS™ Green FPS™

CorePOWER™ Green FPS™ e-Series™ $CROSSVOLT^{\text{TM}}$ Gmax™

GTO™ CTL™ Current Transfer Logic™ IntelliMAX™ DEUXPEED® ISOPLANAR™

Dual Cool™ Marking Small Speakers Sound Louder EcoSPARK® and Better™

MegaBuck™ EfficentMax™ ESBC™ MICROCOUPLER™ MicroFET™

MicroPak™ MicroPak2™ Fairchild® MillerDrive™ Fairchild Semiconductor® MotionMax™ FACT Quiet Series™ mWSaver™ FACT[®] FAST® OptoHiT™ OPTOLOGIC® FastvCore™ OPTOPLANAR® FETBench™

PowerTrench® PowerXS™

Programmable Active Droop™

QFET® QS™ Quiet Series™ RapidConfigure™

Saving our world, 1mW/W/kW at a time™

SignalWise™ SmartMax™ SMART START™

Solutions for Your Success™

STEALTH™ SuperFET® SuperSOT™-3 SuperSOT™-6 SuperSOT™-8 SupreMOS® SyncFET™

Sync-Lock™

SYSTEM ®*

GENERAL

Tipy Poor 177 TinvBoost¹ TinyBuck™ TinyCalc™ TinyLogic® TINYOPTO™ TinyPower™ TinyPWM™ TinyWire™ TranSiC® TriFault Detect™ TRUECURRENT®*

UHC® Ultra FRFET™ UniFET™ VCXTM

uSerDes™

VisualMax™ VoltagePlus™ XS™

*Trademarks of System General Corporation, used under license by Fairchild Semiconductor

DISCLAIMER

FAIRCHILD SEMICONDUCTOR RESERVES THE RIGHT TO MAKE CHANGES WITHOUT FURTHER NOTICE TO ANY PRODUCTS HEREIN TO IMPROVE RELIABILITY, FUNCTION, OR DESIGN. FAIRCHILD DOES NOT ASSUME ANY LIABILITY ARISING OUT OF THE APPLICATION OR USE OF ANY PRODUCT OR CIRCUIT DESCRIBED HEREIN; NEITHER DOES IT CONVEY ANY LICENSE UNDER ITS PATENT RIGHTS, NOR THE RIGHTS OF OTHERS. THESE SPECIFICATIONS DO NOT EXPAND THE TERMS OF FAIRCHILD'S WORLDWIDE TERMS AND CONDITIONS, SPECIFICALLY THE WARRANTY THEREIN, WHICH COVERS THESE PRODUCTS.

LIFE SUPPORT POLICY
FAIRCHILD'S PRODUCTS ARE NOT AUTHORIZED FOR USE AS CRITICAL COMPONENTS IN LIFE SUPPORT DEVICES OR SYSTEMS WITHOUT THE EXPRESS WRITTEN APPROVAL OF FAIRCHILD SEMICONDUCTOR CORPORATION.

- Life support devices or systems are devices or systems which, (a) are intended for surgical implant into the body or (b) support or sustain life, and (c) whose failure to perform when properly used in accordance with instructions for use provided in the labeling, can be reasonably expected to result in a significant injury of the user.
- A critical component in any component of a life support, device, or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or

ANTI-COUNTERFEITING POLICY

Fairchild Semiconductor Corporation's Anti-Counterfeiting Policy. Fairchild's Anti-Counterfeiting Policy is also stated on our external website, www.Fairchildsemi.com, under Sales Support.

Counterfeiting of semiconductor parts is a growing problem in the industry. All manufactures of semiconductor products are experiencing counterfeiting of their parts. Customers who inadvertently purchase counterfeit parts experience many problems such as loss of brand reputation, substandard performance, failed application, and increased cost of production and manufacturing delays. Fairchild is taking strong measures to protect ourselves and our customers from the proliferation of counterfeit parts. Fairchild strongly encourages customers to purchase Fairchild parts either directly from Fairchild or from Authorized Fairchild Distributors who are listed by country on our web page cited above. Products customers buy either from Fairchild directly or from Authorized Fairchild Distributors are genuine parts, have full traceability, meet Fairchild's quality standards for handing and storage and provide access to Fairchild's full range of up-to-date technical and product information. Fairchild and our Authorized Distributors will stand behind all warranties and will appropriately address and warranty issues that may arise. Fairchild will not provide any warranty coverage or other assistance for parts bought from Unauthorized Sources. Fairchild is committed to combat this global problem and encourage our customers to do their part in stopping this practice by buying direct or from authorized distributors.

PRODUCT STATUS DEFINITIONS **Definition of Terms**

Datasheet Identification	Product Status	Definition
Advance Information Formative / In Design		Datasheet contains the design specifications for product development. Specifications may change in any manner without notice.
Preliminary First Production		Datasheet contains preliminary data; supplementary data will be published at a later date. Fairchild Semiconductor reserves the right to make changes at any time without notice to improve design.
No Identification Needed Full Production		Datasheet contains final specifications. Fairchild Semiconductor reserves the right to make changes at any time without notice to improve the design.
Obsolete Not In Production		Datasheet contains specifications on a product that is discontinued by Fairchild Semiconductor. The datasheet is for reference information only.

Rev. 164